

SLP05M

5KV, 180mA SMD High Voltage Diode Fast Recovery

Features

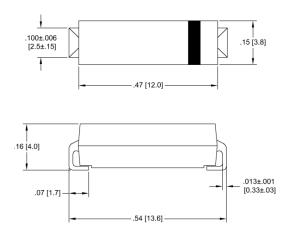
- Surface mount, J-leaded silicon diode design
- Available in cut tape and 1,000 piece reels
- Molded plastic body, ANSI/UL94 V-0 rated material
- RoHS compliant to Directive 2011/65/EC, Article 4(1), Annex II, Annex III, 7(a) and EU RoHS Directive (EU) 2015/863 of March 2015, Amending Annex II



DEVICE ELECTRICAL CHARACTERISTICS

(25°C ambient temperature unless stated otherwise)	Conditions	Symbol	Value
Maximum Repetitive Peak Reverse Voltage	-	V _{RRM}	5,000 Volts
Average Forward Current Maximum	$T_A = 55^{\circ}C$	I _{FAVM}	180 mA
Average Forward Current Maximum	$T_C = 55^{\circ}C$	I _{FAVM}	500 mA
Average Forward Current Maximum	$T_L = 55^{\circ}C$	I _{FAVM}	1000 mA
Average Forward Current Maximum	T _L = 100°C	I _{FAVM}	500 mA
Thermal Resistance (typical) in °C/W	Leads mounted on 5mm x 5mm	RΘ	RO _{JA} RO _{JC} RO _{JL}
	copper pad.		70 27 17
Maximum Forward Voltage Drop	$I_{F} = 200 \text{mA}$	V_{F}	8.5 Volts
Maximum Surge Current Rating	8.3msec, half sine	I _{FSM}	15 Amps
Maximum Reverse Current	at rated V _{RRM}	I_R	0.5 μΑ
Maximum Reverse Recovery Time	IF=100mA; IR=-200mA; IRR=-50mA	TRR	75 ηs
Junction Capacitance (typical)	f = 1MHz, Vr = 0VDC	CJ	7.5 pf
Maximum Junction Temperature	-	Τ _J	150°C
Storage Temperature Range	-	T _{STG}	-55°C to 150°C

MECHANICAL DATA:



DIMENSIONS IN INCHES (MM)



VERSION: 1.0

Effective: 31 January 2017

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SLP10M

10KV, 100mA SMD High Voltage Diode Fast Recovery

Features

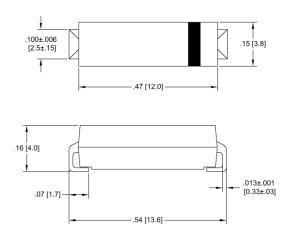
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- Available in cut tape and 1,000 piece reels
- Molded plastic body, ANSI/UL94 V-0 rated material
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DEVICE ELECTRICAL CHARACTERISTICS

(25°C ambient temperature unless stated otherwise)	Conditions	Symbol	Value
Maximum Repetitive Peak Reverse Voltage	-	V_{RRM}	10,000 Volts
Average Forward Current Maximum	$T_A = 55^{\circ}C$	I _{FAVM}	100 mA
Average Forward Current Maximum	$T_C = 55^{\circ}C$	I _{FAVM}	300 mA
Average Forward Current Maximum	$T_L = 55^{\circ}C$	I _{FAVM}	450 mA
Average Forward Current Maximum	$T_{L} = 100^{\circ}C$	I _{FAVM}	230 mA
Thermal Resistance (typical) in °C/W	Leads mounted on 5mm x 5mm	RÐ	$R\Theta_{JA}$ $R\Theta_{JC}$ $R\Theta_{JL}$
	copper pad.		70 27 17
Maximum Forward Voltage Drop	$I_F = 200 \text{mA}$	V_{F}	15.8 Volts
Maximum Surge Current Rating	8.3msec, half sine	I _{FSM}	15 Amps
Maximum Reverse Current	at rated V _{RRM}	I_R	0.5 μΑ
Maximum Reverse Recovery Time	IF=100mA; IR=-200mA; IRR=-50mA	TRR	75 ηs
Junction Capacitance (typical)	f = 1MHz, Vr = 0VDC	CJ	3.7 pf
Maximum Junction Temperature	-	TJ	150°C
Storage Temperature Range	-	T _{STG}	-55°C to 150°C

MECHANICAL DATA:



DIMENSIONS IN INCHES (MM)



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